

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
650V	260mΩ@10V	15A

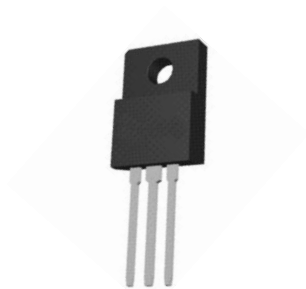
Feature

- Low on-resistance
- Low gate charge

Application

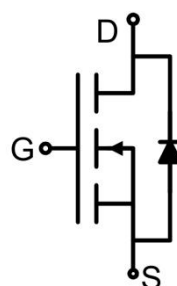
- Power factor correction (PFC)
- Uninterruptible power supply (UPS)

Package

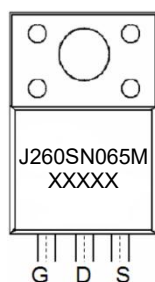


ITO-220AB

Circuit diagram



Marking



Absolute maximum ratings (T_c=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage	V _{GS}	±30	V
Continuous Drain Current	I _D	15	A
Pulsed Drain Current ¹⁾	I _{DM}	45	A
Single Pulse Avalanche Energy ²⁾	E _{AS}	270	mJ
Power Dissipation ³⁾	P _D	32	W
Thermal Resistance Junction to Case	R _{θJC}	3.9	°C/W
Operating Junction Temperature	T _J	-55 ~ +150	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Electrical characteristics (T_J=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	650			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μA
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±30V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.5	3.5	4.5	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} =10V, I _D =7.5A		200	260	mΩ
Dynamic characteristics ⁴⁾						
Input Capacitance	C _{iss}	V _{DS} =100V, V _{GS} =0V, f =1MHz		1099		pF
Output Capacitance	C _{oss}			52		
Reverse Transfer Capacitance	C _{rss}			1		
Total Gate Charge	Q _g	V _{DS} =325V, V _{GS} =10V, I _D =15A		25.2		nC
Gate-Source Charge	Q _{gs}			5.9		
Gate-Drain Charge	Q _{gd}			9.7		
Turn-on delay time	t _{d(on)}	V _{DS} =325V, V _{GS} =10V, I _D =15A R _G =25Ω		25		nS
Turn-on rise time	t _r			34.5		
Turn-off delay time	t _{d(off)}			107		
Turn-off fall time	t _f			28		
Source-Drain Diode characteristics						
Source-drain current	I _S				15	A
Diode Forward voltage	V _{SD}	V _{GS} =0V, I _S =15A			1.3	V
Reverse Recovery Time	T _{rr}	V _{GS} =0V, I _S =15A di/dt =100A/us		260		nS
Reverse Recovery Charge	Q _{rr}			3.5		μC

Notes:

- 1) The data tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.
- 2) The EAS data shows Max. rating . L=60mH, I_{AS} =3A, V_{DO} =50V, R_G=25Ω, Starting at T_J = 25°C.
- 3) The power dissipation is limited by 150°C junction temperature.
- 4) Guaranteed by design, not subject to production testing.

Typical Characteristics

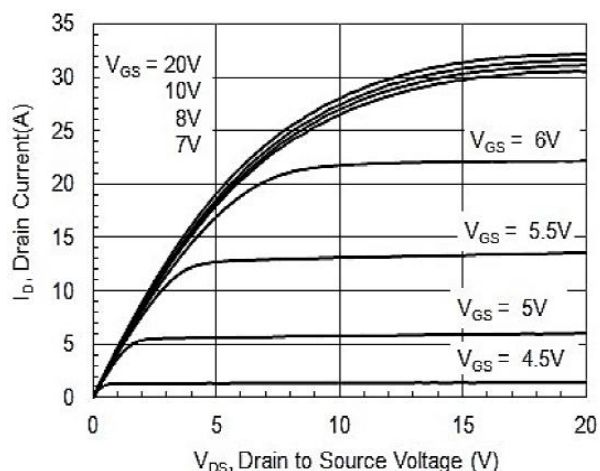


Figure1: Output characteristics

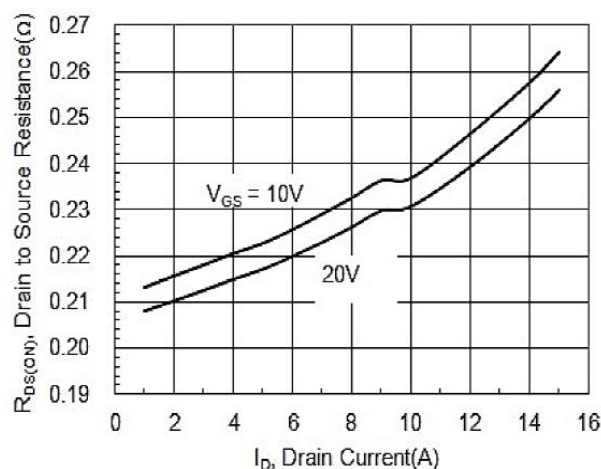


Figure2: Drain source on state resistance

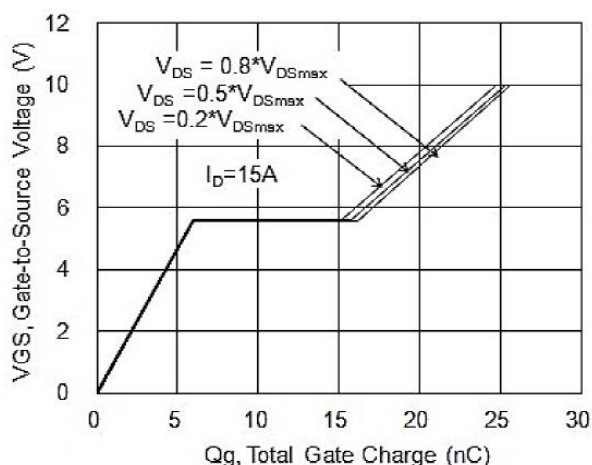


Figure3: Gate charge characteristics

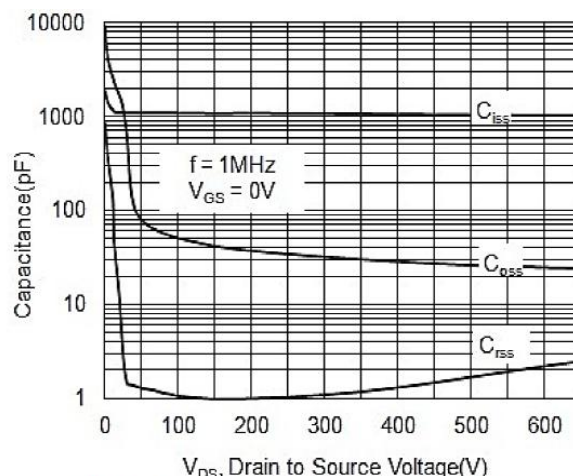


Figure4: Capacitance Characteristics

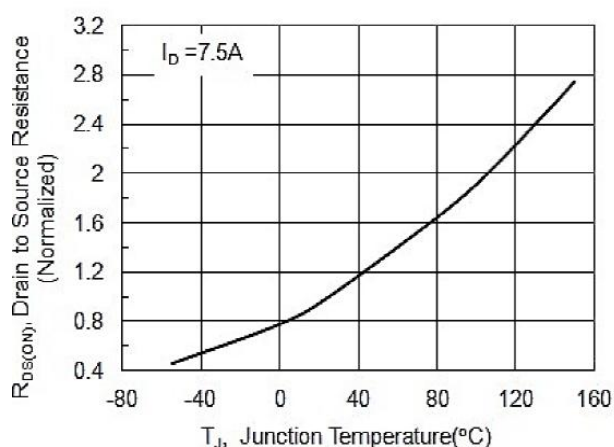


Figure5: $R_{ds(on)}$ Vs junction temperature

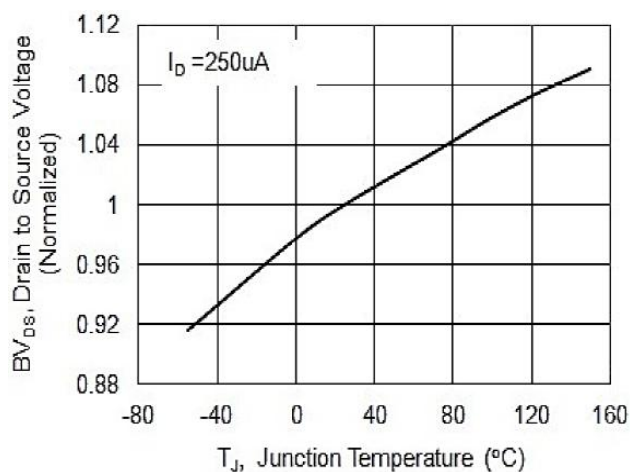


Figure6: BV_{DS} vs junction temperature

Typical Characteristics

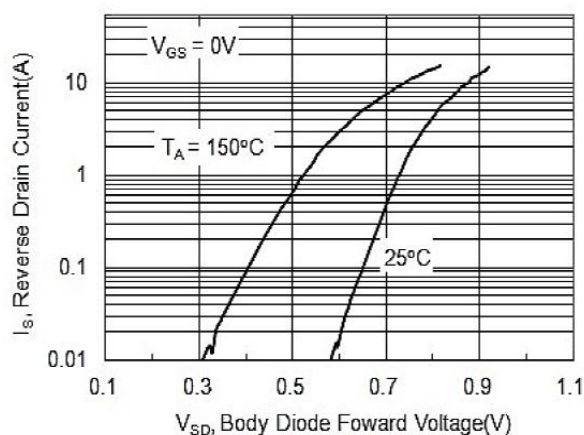


Figure7:VGS (th) vs junction temperature

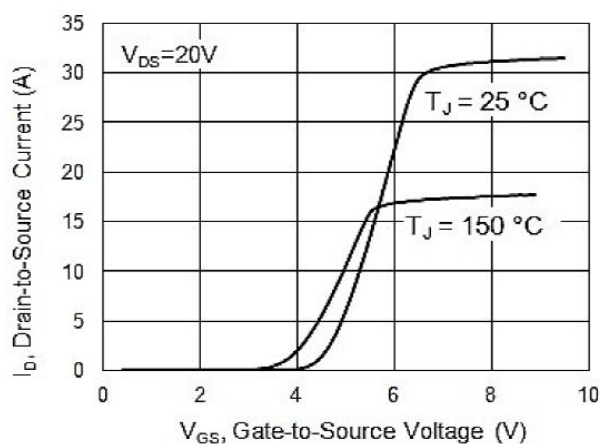


Figure8: Transfer characteristics

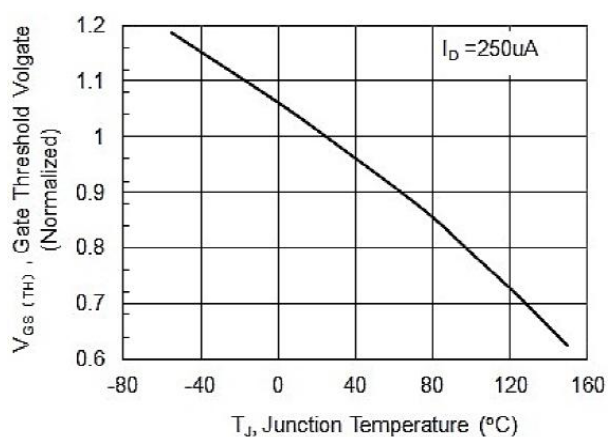


Figure9: VGS (th) vs junction temperature

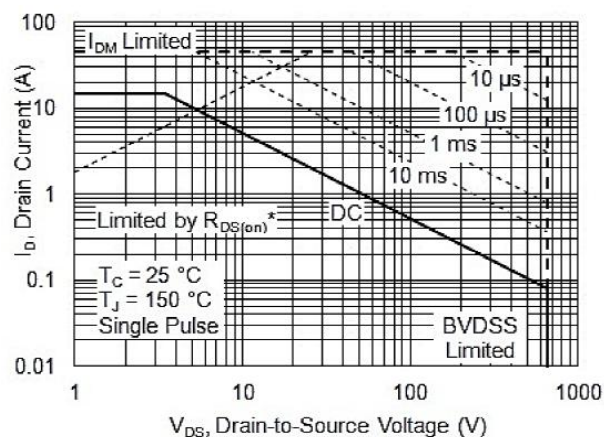


Figure10: Safe operating area

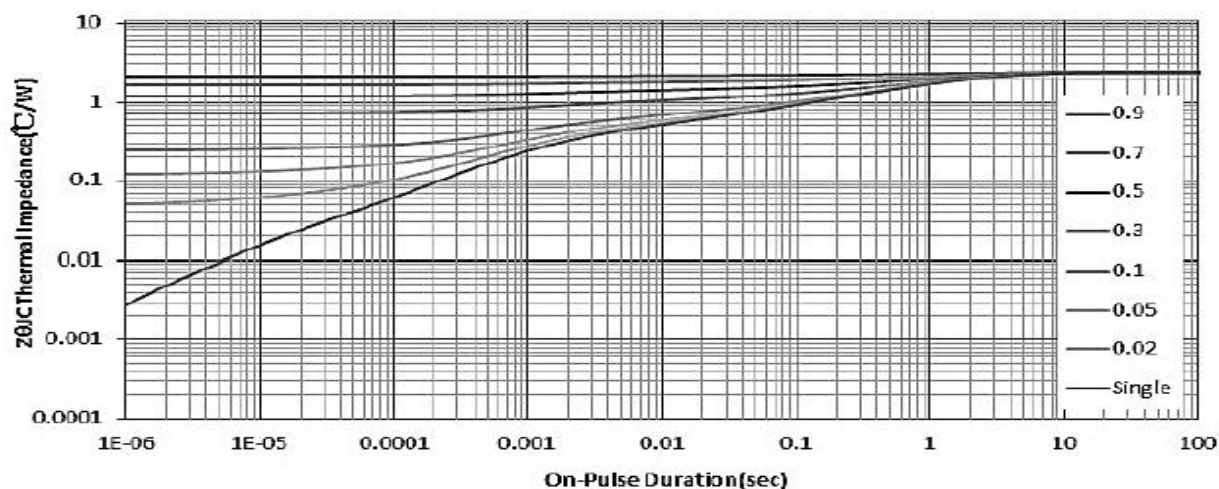
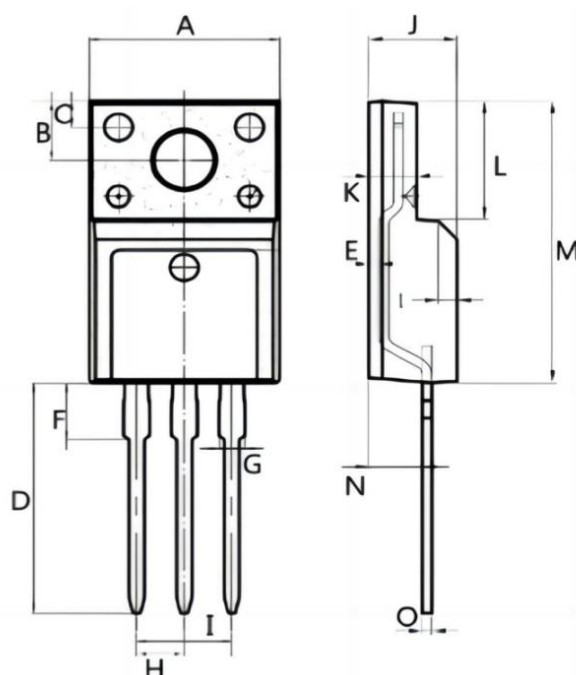


Figure11: Transient thermal impedance

ITO-220AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	9.900	10.300	0.390	0.406
B	2.900	3.500	0.114	0.138
C	1.150	1.450	0.045	0.057
D	12.750	13.250	0.502	0.522
E	0.550	0.750	0.022	0.030
F	3.100	3.500	0.122	0.138
G	1.250	1.450	0.049	0.057
H	2.540 BSC.		0.100 BSC.	
I	5.080 BSC.		0.200 BSC.	
J	4.550	4.750	0.179	0.187
K	2.400	2.700	0.094	0.106
L	6.350	6.750	0.250	0.266
M	15.000	16.000	0.591	0.630
N	2.750	3.150	0.108	0.124
O	0.450	0.600	0.018	0.024